

Intel® Firmware Support Package (Intel® FSP) for with Intel® Atom™ processor E3900 product family (formerly Apollo Lake), MR1

Release Notes

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Revision History

These are the main releases of Intel® Firmware Support Package (Intel® FSP) for the Intel® Atom™ processor E3900 product family (formerly Apollo Lake):

Date	Revision	Description
November 2, 2015	ALPHA	Alpha Release
February 17, 2016	BETA1	Beta 1 Release
May 13, 2016	BETA2	Beta 2 Release with FSP 0.8.1
July 27, 2016	GOLD	Gold Release with FSP 1.1.0
September 9, 2016	MR1	MR1 Release with IOTG FSP 1.1.4.1



1.0 Introduction

This package contains required binary image(s) and collateral for the Intel® Firmware Support Package (Intel® FSP) for the Intel® Atom™ processor E3900 product family (formerly Apollo Lake). The FSP packaged in this release is intended for IOTG usage only.

This document provides system requirements, installation instructions, issues and limitations, and legal information.

To learn more about this product, see:

- New and previously new features listed in <u>Section 2.0, New in This Release</u>.
- Reference documentation listed in <u>Section 1.2, Related Documentation, Tools, and Packages</u>.
- Installation instructions in <u>Section 5.1, How to Install This Release</u>.

This release provides support for FSP EAS 2.0, for more information please view the related document Intel® Firmware Support Package (Intel® FSP) External Architecture Specification (EAS) v2.0.

The following table lists the relevant platform software components used during development and validation of this release.

Table 1. Platform Software Component Information

Component	Alpha
Microcode Update (Bx-stepping)	M01506c9_0000001c

1.1 Terminology

The following terms are used in this document.

Table 2. Terminology

Term	Description
API	Application Programming Interface
BSF	Binary Settings File
ВСТ	Binary Configuration Tool
CRB	Customer Reference Board



Term	Description
Intel® EDC	Intel® Embedded Design Center
Intel® FSP	Intel® Firmware Support Package
SoC	System on Chip

1.2 Related Documentation, Tools, and Packages

Table 3. Related Documentation, Tools, and Packages

Document	Location
Intel® Firmware Support Package (Intel® FSP) for the Apollo Lake Platform Integration Guide	Available in this release package
Intel® Binary Configuration Tool for Intel® Firmware Support Package	www.intel.com/fsp
Intel® Firmware Support Package (Intel® FSP) External Architecture Specification (EAS) v2.0	www.intel.com/content/d am/www/public/us/en/d ocuments/technical- specifications/fsp- architecture-spec-v2.pdf

1.3 Intended Audience

The intended audience is platform and system developers who intend to use an Intel® FSP-based boot loader for the firmware solution for their overall design based on the Intel® Atom™ processor E3900 product family (formerly Apollo Lake). This group includes, but is not limited to, system BIOS developers, boot loader developers, and system integrators.

1.4 Customer Support

Intel offers support for this software at the API level only, defined in the *Intel® FSP Integration Guide* and reference manuals listed in <u>Section 1.2, Related Documentation</u>, <u>Tools</u>, and <u>Packages</u>.



2.0 New in This Release

2.1 New Features

N/A

2.2 Gold Features

• N/A

2.3 Beta 2 Features

- FSP BCT configuration support (via BCT 3.2.2 or newer versions)
- Support for eMMC firmware boot

2.4 Beta 1 Features

• FSP BCT configuration support (via BCT 3.2.1)

2.5 Alpha Features

- Initial release
- Support for SPI firmware boot
- Support for Intel® Firmware Support Package (Intel® FSP) FVs: FVIBBL.Fv, FVIBBM.Fv, and FVOBB.Fv



3.0 Limitations

3.1 Current Release

• The BCT tool used with this release must be version 3.2.2 or newer, older versions of BCT tool may not be compatible with the newer FSP 2.0 architecture. For more information please view the related document Intel® Firmware Support Package (Intel® FSP) External Architecture Specification (EAS) v2.0.

3.2 Previous Releases

- This FSP does not support full RMT data output for compatibility with RMT analysis tool. This support is planned to be enabled in the next release. This limitation has been addressed as of MR1, using the debug FSP binary and enabling the FSP-M UPD RmtMode (e.g. set to 0x3) will yield RMT data printing for use with RMT analysis tool.
- When configuring the provided Fsp.fd binary using BCT tool the setting for DDR3L Page Size will show a blank field with default value 0x0 but should only show 1KB or 2KB option. The behavior of the 0x0 value results in the same behavior as when 1KB is selected. This limitation has been addressed as of Beta 2.
- Rebasing of Intel® Firmware Support Package (Intel® FSP) via Intel® Binary Configuration Tool is not supported in this release. Support is expected in the Beta release. This limitation has been addressed as of Beta 1.
- Memory parameters in this Intel® FSP release are not configurable. This release can support only the same memory configuration as that of the Leaf Hill CRB at this time. This limitation has been addressed as of Beta 1.



4.0 Known Issues

4.1 Current Release

• The Intel® Atom™ Processor A3940 SKU has issue to boot using the Leaf Hill CRB due to an MRC limitation in this release of FSP. The issue will be resolved in a future release of FSP.

4.2 Previous Releases

- There is a mistake regarding the NPK Enable Mode configurable option displayed when using BCT tool to configure the FSP binary. The duplicate of default option will appear blank but it should be displaying 3 for Auto which is the default setting. The valid list of options for this field are 0:Disable, 1:Enable, 2:Debugger, 3:Auto(Default). This will be fixed in the next release of FSP. This issue has been resolved as of MR1.
- There is some issue with FSP performing OBB loading and TPM initialization when using Micron (Numonyx) N25Q128A11 SPI chip. Recommend to either use eMMC firmware booting or Winbond W25Q128FW SPI chip. No plan to investigate a solution to this.
- There is a duplicate of ISH Controller configurable option displayed when using BCT tool to configure the FSP binary. The duplicate of ISH Controller is supposed to be for "Enable/Disable BIOS Interface Lock Down bit to prevent writes to the Backup Control Register. 0:Disable, 1:Enable(Default)." This will be fixed in the next release of FSP. This issue has been resolved as of Gold.
- Issue configuring xHCI option in BCT issue; the default value is set as "Auto" but only allows to be set as enabled or disabled, should be changed to be a 4-option type field: {Mode of operation of xHCI controller. 0:Disable, 1:Enable, 2:Auto(Default), 3:SmartAuto.}. Can be worked around by overriding the UPD value in boot loader code before calling FSP silicon initialization if desired. Will be fixed to provide correct configurable options via BCT in a future release. This issue has been resolved as of Gold.
- The most current release of Intel® Binary Configuration Tool (3.2.0) is incompatible with the Intel® Firmware Support Package (Intel® FSP) binary included in this release. Settings can be overridden from within the boot loader call prior to Intel® FSP API calls. This issue has been resolved as of Beta 1.





5.0 Where to Find the Release

This package can be found at https://github.com/IntelFsp/FSP.

5.1 How to Install This Release

This release can be installed on either a Windows* or a Linux* system.

For Windows* systems:

1. Run the .exe file to perform the installation.

For Linux* systems:

- 1. Extract the contents of the .tgz file.
- 2. See the Readme_Extract.txt file for further instructions to complete the installation.

Note: For more information about integrating the Intel® FSP APIs into the boot loader code, see Intel® Firmware Support Package (Intel® FSP) for the Apollo Lake Platform Integration Guide.



6.0 Release Content

This release contains:

- Intel® FSP Integration Guide
- Intel® FSP Binary
- Binary Settings File (BSF)
- Graphics VBT and BSF file
- Release Notes



7.0 Hardware and Software Compatibility

7.1 Supported Hardware

This Intel® Firmware Support Package (Intel® FSP) release is specifically targeted for the Intel® Atom™ processor E3900 product family (formerly Apollo Lake).

7.2 Supported Operating Systems

This release can be installed on either a Windows* or a Linux* system. However, the Intel® FSP binary itself can be used with any software development environment to generate a complete boot loader solution.

The software in this release has been validated on customer reference boards (CRBs) with the boot loader and operating systems listed in the following table.

Table 4. Operating System/Boot Loader Support

Product Family	Boot Loader	Operating System
Intel® Atom™ processor E3900 product family (formerly Apollo Lake)	Coreboot* with the UEFI payload Coreboot* with U-Boot payload	Yocto Project* Windows 10 (Core and IOT)



8.0 Configuration

Intel® Binary Configuration Tool (BCT) for Intel® Firmware Support Package (Intel® FSP) is provided as a companion tool and is intended to be used to:

- Customize the Intel® FSP binary configuration options based on the Binary Settings File (BSF).
- Rebase the Intel® FSP binary to a different base address.

It is recommended to use the latest version of Intel® Binary Configuration Tool with this release.

See Intel® Binary Configuration Tool User Guide for the usage instructions. See Section 1.2, Related Documentation, Tools, and Packages, for information on where to download the tool.

8.1 Rebasing

When integrating Intel® FSP with a boot loader, place Intel® FSP at the same base address that it is configured to. Intel® Binary Configuration Tool can be used to rebase the Intel® FSP binary.

8.2 Microcode

Use the latest microcode when integrating Intel® FSP. Any processor that does not have the correct microcode update loaded is considered to be operating out of specification. See the integration guide for more details regarding microcode loading.